



## Material Content Data Sheet



Halogen-Free

<b>Sales Product Name</b>	BTF3050TE	<b>Issued</b>	12. May 2021
<b>MA#</b>	MA001854622		
<b>Package</b>	PG-TO252-5-11	<b>Weight*</b>	355.34 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	1.424	0.40	0.40	4008	4008
leadframe	inorganic material	phosphorus	7723-14-0	0.061	0.02		173	
	non noble metal	iron	7439-89-6	0.205	0.06		576	
	non noble metal	copper	7440-50-8	204.243	57.47	57.55	574789	575538
wire	non noble metal	aluminium	7429-90-5	1.302	0.37	0.37	3664	3664
encapsulation	inorganic material	zinc oxide	1314-13-2	1.414	0.40		3980	
	miscellaneous	miscellaneous	-	7.071	1.99		19899	
	plastics	epoxy resin	-	21.213	5.97		59698	
	inorganic material	silicon dioxide	60676-86-0	111.722	31.44	39.80	314412	397989
lead finish	non noble metal	tin	7440-31-5	5.072	1.43	1.43	14275	14275
plating	inorganic material	phosphorus	7723-14-0	0.000			1	
	non noble metal	nickel	7440-02-0	0.076	0.02	0.02	214	215
solder	non noble metal	tin	7440-31-5	0.031	0.01		86	
	noble metal	silver	7440-22-4	0.038	0.01		108	
	non noble metal	lead	7439-92-1	1.463	0.41	0.43	4117	4311
*deviation	< 10%	Sum in total:				100.00		1000000

### Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and contains Pb according RoHS exemption 7a, Lead in high melting temperature type solders.

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